#### TOSHIBA PHOTOCOUPLER PHOTO RELAY

# **TLP3113**

# MEASUREMENT INSTRUMENTS LOGIC IC TESTERS / MEMORY TESTERS BOARD TESTERS / SCANNERS

The TOSHIBA TLP3113 Mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP3113 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Its characteristics include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency mearsuring instruments.

#### **FEATURES**

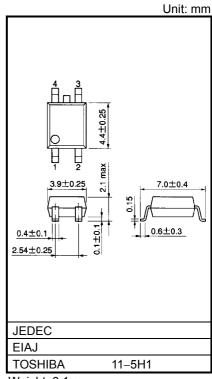
• 4 pin SOP (2.54SOP4) : 2.1 mm high, 2.54 mm pitch

• 1-Form-A

Peak Off-State Voltage : 40 V (MIN.)
 Trigger LED Current : 4 mA (MAX.)
 On-State Current : 80 mA (MAX.)

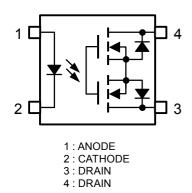
• On-State Resistance :  $35 \Omega$  (MAX.),  $25 \Omega$  (TYP.) • Output Capacitance : 1.4 pF (MAX.), 0.6 pF (TYP.)

• Isolation Voltage : 1500 Vrms (MIN.)

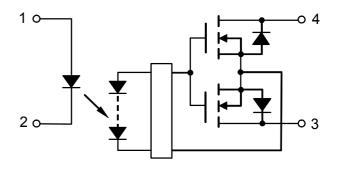


Weight: 0.1 g

#### **PIN CONFIGURATION (TOP VIEW)**



#### **SCHEMATIC**



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### **MAXIMUM RATINGS (Ta = 25°C)**

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	IF	50	mA
Ω	Forward Current Derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C
当	Reverse Voltage	$V_{R}$	5	V
	Junction Temperature	Tj	125	°C
<u>~</u>	Off-State Output Terminal Voltage	V <sub>OFF</sub>	40	V
DETECTOR	On-State Current	I <sub>ON</sub>	80	mA
ĒĒ	On-State Current Derating (Ta ≥ 25°C)	Δl <sub>ON</sub> /°C	-0.8	mA/°C
	Junction Temperature	Tj	125	°C
Storage Temperature Range		T <sub>stg</sub>	-40~125	°C
Operating Temperature Range		T <sub>opr</sub>	-20~85	°C
Lead Soldering Temperature (10 s)		T <sub>sol</sub>	260	°C
Isolat	tion Voltage (AC, 1 minute, R.H. $\leq$ 60%) (NOTE1)	BV <sub>S</sub>	1500	Vrms

(NOTE1): Device considered a two-terminal device: Pins 1 and, 2 shorted together, and pins 3 and 4 shorted together.

#### **CAUTION**

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

#### **RECOMMENDED OPERATING CONDITIONS**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	$V_{DD}$	_	_	32	V
Forward Current	I <sub>F</sub>	10	_	30	mA
On-State Current	I <sub>ON</sub>	_	_	80	mA
Operating Temperature	T <sub>opr</sub>	25	_	60	°C

# INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V		_	10	μΑ
	Capacitance	C <sub>T</sub>	V = 0, f = 1 MHz		15		pF
CTOR	Off-State Current	l <sub>OFF</sub>	V <sub>OFF</sub> = 30 V, Ta = 50°C	l		1000	pА
DETECTOR	Capacitance	C <sub>OFF</sub>	V = 0, f = 100 MHz, t < 1 s	_	0.6	1.4	pF

# **COUPLED ELECTRICAL CHARACTERISTICS (Ta = 25°C)**

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Trigger LED Current	I <sub>FT</sub>	I <sub>ON</sub> = 80 mA	_	_	4	mA
Return LED Current	I <sub>FC</sub>	I <sub>OFF</sub> = 10 μA	0.2	0.75	_	mA
On-State Resistance	R <sub>ON</sub>	$I_{ON} = 80 \text{ mA}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	_	25	35	Ω

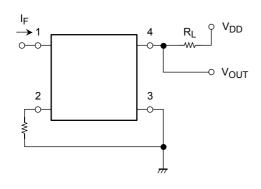
## **ISOLATION CHARACTERISTICS (Ta = 25°C)**

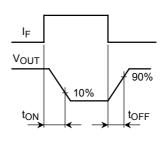
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Capacitance Input to Output	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation Resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≦ 60%	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
		AC, 1 minute	1500	_	_	Vrms
Isolation Voltage	$BV_S$	AC, 1 second (in oil)	_	3000	_	VIIIIS
		DC, 1 minute (in oil)	_	3000	_	Vdc

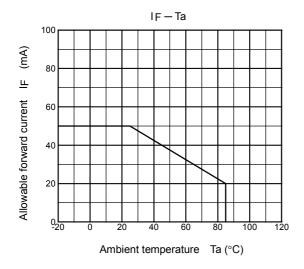
# **SWITCHING CHARACTERISTICS (Ta = 25°C)**

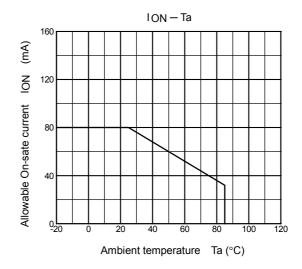
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Turn-on Time	t <sub>ON</sub>	$R_L = 200 \Omega$ (NOTE 2)	_	_	500	μS
Turn-off Time	t <sub>OFF</sub>	$V_{DD} = 10 \text{ V}, I_F = 10 \text{ mA}$	_	_	500	μδ

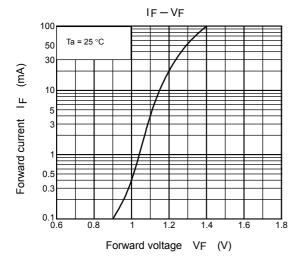
(NOTE 2): SWITCHING TIME TEST CIRCUIT

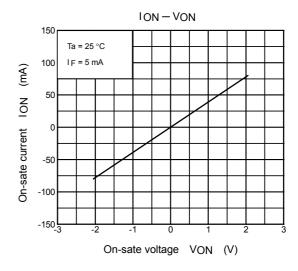


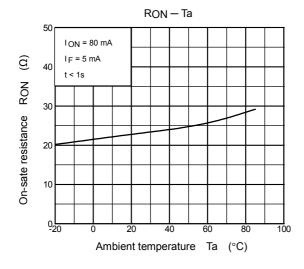


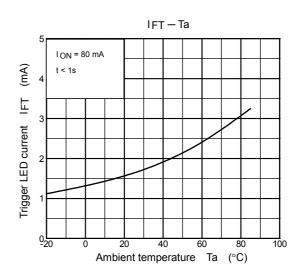


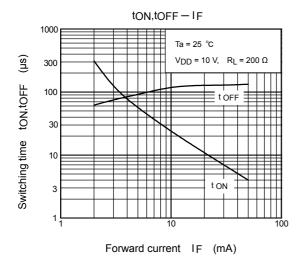


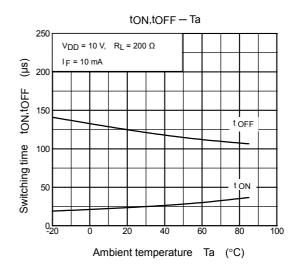


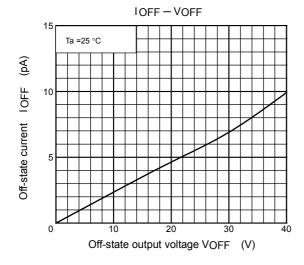


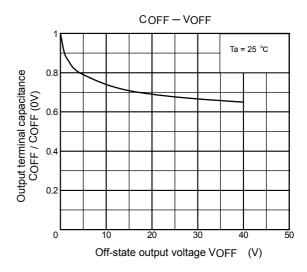












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